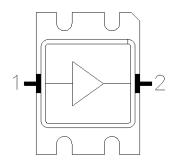
4.7 to 5.1 GHz GaN HEMT Power Amplifier



Functional Block Diagram



Pin#	Symbol	Description			
1	Vg/	Gate voltage/RF Input			
	RF IN	matched to 50Ω			
2	Vd/	Drain voltage/RF			
	RF OUT	Output matched to 50Ω			
Package	Ground	Source connected to			
Bottom	Ground	ground			

Product Description

MECPKC45W is a single stage High Power Amplifier designed by MEC for C-Band applications and based on a 0.5µm GaN on SiC process.

The MECPKC45W provides more than 40W of output power in the frequency range from 4.7 GHz to 5.1 GHz with a PAE higher than 40% and 14 dB of Linear Gain.

The MECPKC45W is provided within a CuMo power package for optimal thermal dissipation. It is fully matched to 50 Ω at the pin of the package.

Advanced Thin Film technology manufacturing has been exploited to get a reliable and reproducible product performance.

Main Features

- 0.5µm GaN HEMT Technology
- 4.7 5.1 GHz full performances Frequency Range
- more than 40W Output Power @ Pin 36 dBm
- more than 40% PAE @ Pin 36 dBm
- 14 dB Linear Gain
- Bias: VDD = 40V, Idq = 400 mA, Vg = -1.9V (Typ.)
- CuMo Power package with RFin and RFout pin interfaces
- Fully matched to 50 Ω within the package

Applications

- Radar
- Telecom

4.7 to 5.1 GHz GaN HEMT Power Amplifier



Main Characteristics*

Test Conditions: $T_{base_plate} = 25^{\circ}C$, Vdd = 40 V, Idq = 400 mA, Pulse Width = 50 μs , Duty Cycle = 15%

Parameter	Min	Тур	Max	Unit
Operating frequency	4.7		5.1	GHz
Small Signal Gain	13.9	14.3	14.7	dB
Input Return Loss			-5	dB
Output Return Loss			-11.9	dB
Output Power @ Pin = 36 dBm	41		49	W
Power Added Efficiency @ Pin = 36 dBm	41		46	%
Drain Supply Voltage		40		V
Supply Quiescent Drain Current		400		mA
Supply Drain Current @ Pin = 36 dBm	2.1		2.5	A
Gate Voltage		1.9		V

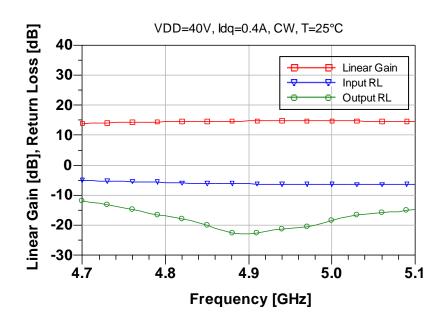
^{*}Performances described in this document are based on preliminary on-jig characterization. More details are available upon request at contact.mec@mec-mmic.com

4.7 to 5.1 GHz GaN HEMT Power Amplifier

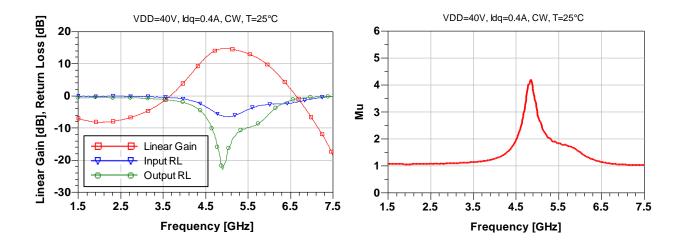


Typical Measured Performances

Linear Gain, Input and Output Return Loss Vs. Frequency (Operating Band)



Linear Gain, Input and Output Return Loss Vs. Frequency (Broadband)**

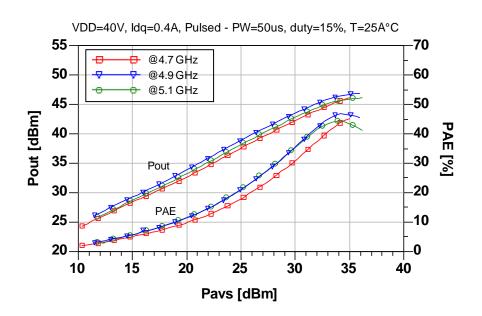


^{**} S-parameter file is available upon request at contact.mec@mec-mmic.com

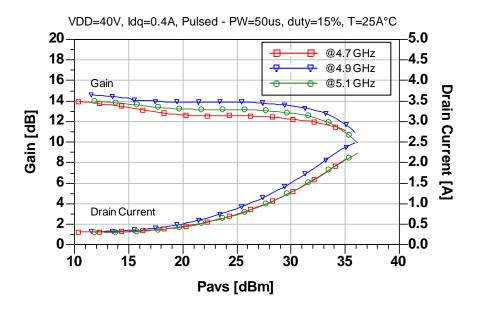
4.7 to 5.1 GHz GaN HEMT Power Amplifier



Output Power and PAE Vs. Input Power



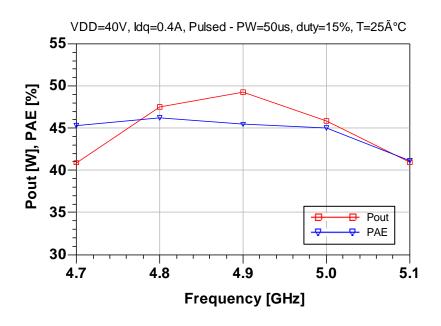
Gain and Drain Current Vs. Input Power



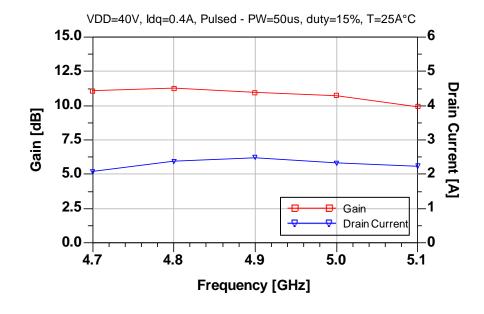
4.7 to 5.1 GHz GaN HEMT Power Amplifier



Output Power and PAE @ Pin = 36 dBm Vs. Frequency



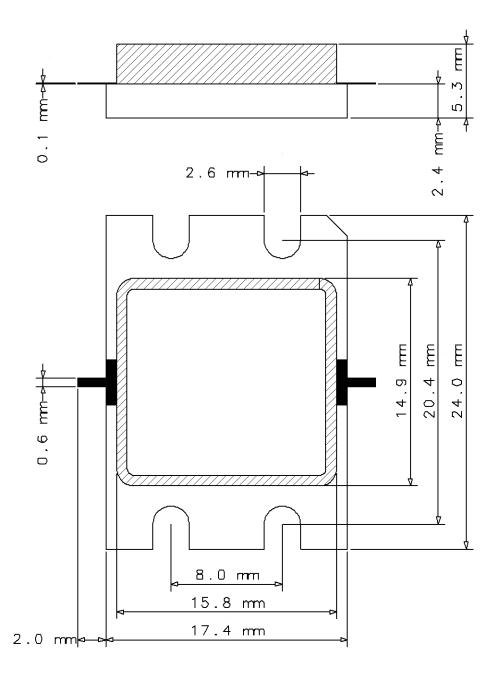
Gain and Drain Current @ Pin = 36 dBm Vs. Frequency



4.7 to 5.1 GHz GaN HEMT Power Amplifier



Package Outline

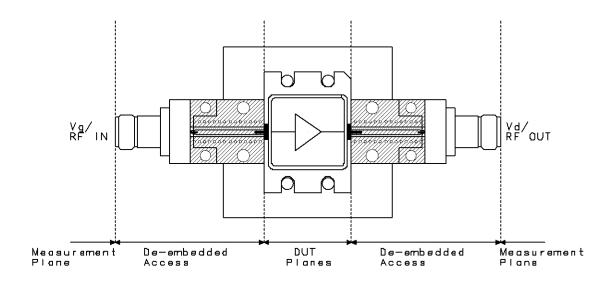


Detailed package dimensions and characteristics are available upon request at **contact.mec@mec-mmic.com**

4.7 to 5.1 GHz GaN HEMT Power Amplifier



Test Board



The device characteristics were measured at the package pins, by de-embedding at both ports the Shielded Conductor-backed Coplanar Waveguide access plus the input and output connectors by a TRL calibration.

Further details of the Test Board are available upon request at contact.mec@mec-mmic.com.

To implement RF to DC decoupling and improve input return loss, custom test-fixtures can be designed and provided upon request (**contact.mec@mec-mmic.com**).

Bias Procedure

Bias-Up

- 1. Vg set to -5 V.
- 2. Vd set to +40 V.
- 3. Adjust Vg until quiescent Id is 400 mA (Vg = -1.9 V Typical).
- 4. Apply RF signal.

Bias-Down

- 1. Turn off RF signal.
- 2. Reduce Vg to -5 V (Id0 \approx 0 mA).
- 3. Set Vd to 0 V.
- 4. Set Vg to 0 V.

4.7 to 5.1 GHz GaN HEMT Power Amplifier



Contact Information

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Notice

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